

## CDx4AC245、CDx4ACT245 三态同相八路总线收发器

## 1 特性

- 缓冲输入
- 典型传播延迟
  - $V_{CC} = 5V$ 、 $T_A = 25^\circ C$  且  $C_L = 50pF$  时为 4ns
- 防 SCR 闩锁 CMOS 工艺和电路设计
- 双极 FAST™/AS/S 的速度，同时功耗显著降低
- 平衡传播延迟
- 交流类型的工作电压范围为 1.5V 至 5.5V，并在电源电压的 30% 时具有平衡的抗噪性能
- $\pm 24mA$  输出驱动电流
  - 扇出到 15 个 FAST™ IC
  - 驱动  $50\Omega$  传输线路

## 2 说明

'AC245 和 'ACT245 是采用高级 CMOS 逻辑技术的八路总线收发器。

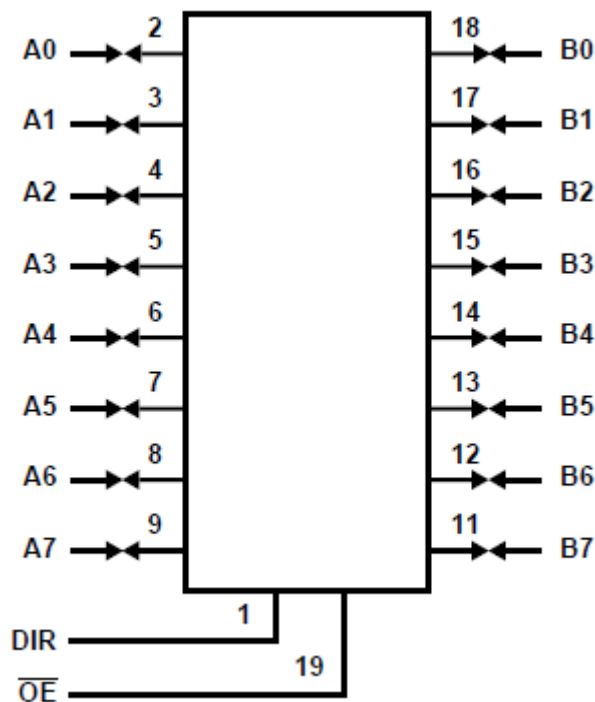
## 器件信息

| 器件型号                     | 封装 <sup>(1)</sup> | 封装尺寸 <sup>(2)</sup> | 本体尺寸 <sup>(3)</sup> |
|--------------------------|-------------------|---------------------|---------------------|
| CD74AC245/<br>CD74ACT245 | N ( PDIP , 20 )   | 24.33mm x 9.4mm     | 24.33mm x 6.35mm    |
|                          | DW ( SOIC , 20 )  | 12.80mm x 10.3mm    | 12.80mm x 7.50mm    |
| CD54AC245/<br>CD54ACT245 | J ( CDIP , 20 )   | 24.2mm x 7.62mm     | 24.2mm x 6.92mm     |
| CD74ACT245               | DB ( SSOP , 20 )  | 7.2mm x 7.8mm       | 7.2mm x 5.3mm       |

(1) 更多信息，请参阅第 10 节。

(2) 封装尺寸 ( 长 × 宽 ) 为标称值，并包括引脚 ( 如适用 )。

(3) 本体尺寸 ( 长 × 宽 ) 为标称值，不包括引脚。



逻辑图 ( 正逻辑 )



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## 3 Pin Configuration and Functions

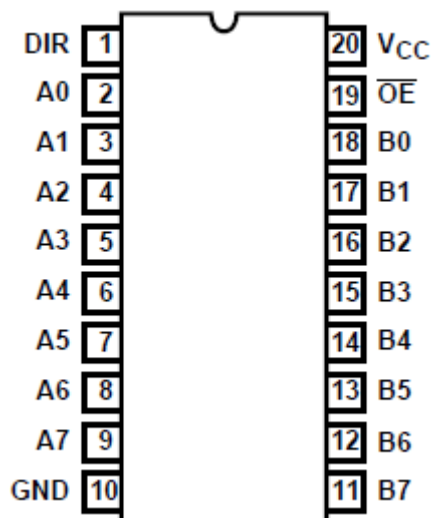


图 3-1. CD54AC245, CD54ACT245 (CERDIP), CD74AC245, CD74ACT245 (PDIP, SOIC, SSOP) Top View

### Pin Functions

| PIN |                 | TYPE <sup>1</sup> | DESCRIPTION     |
|-----|-----------------|-------------------|-----------------|
| NO. | NAME            |                   |                 |
| 1   | DIR             | I/O               | Direction Pin   |
| 2   | A0              | I/O               | A1 Input/Output |
| 3   | A1              | I/O               | A2 Input/Output |
| 4   | A2              | I/O               | A3 Input/Output |
| 5   | A3              | I/O               | A4 Input/Output |
| 6   | A4              | I/O               | A5 Input/Output |
| 7   | A5              | I/O               | A6 Input/Output |
| 8   | A6              | I/O               | A7 Input/Output |
| 9   | A7              | I/O               | A8 Input/Output |
| 10  | GND             | —                 | Ground Pin      |
| 11  | B7              | I/O               | B7 Input/Output |
| 12  | B6              | I/O               | B6 Input/Output |
| 13  | B5              | I/O               | B5 Input/Output |
| 14  | B4              | I/O               | B4 Input/Output |
| 15  | B3              | I/O               | B3 Input/Output |
| 16  | B2              | I/O               | B2 Input/Output |
| 17  | B1              | I/O               | B1 Input/Output |
| 18  | B0              | I/O               | B0 Input/Output |
| 19  | OE              | I/O               | Output Enable   |
| 20  | V <sub>CC</sub> | —                 | Power Pin       |

(1) Signal Types: I = Input, O = Output, I/O = Input or Output

## 4 Specifications

### 4.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                |                                              |                                        | MIN  | MAX       | UNIT |
|----------------|----------------------------------------------|----------------------------------------|------|-----------|------|
| $V_{CC}$       | Supply voltage                               |                                        | -0.5 | 6         | V    |
| $I_{IK}$       | Input diode current                          | $V_I < -0.5V$ or $V_I > V_{CC} + 0.5V$ |      | $\pm 20$  | mA   |
| $I_{OK}$       | Output diode current                         | $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$ |      | $\pm 50$  | mA   |
| $I_O$          | Output source or sink current per output pin | $V_O > -0.5V$ or $V_O < V_{CC} + 0.5V$ |      | $\pm 50$  | mA   |
| $I_{OK}^{(2)}$ | $V_{CC}$ or ground current                   | $I_{CC}$ or $I_{GND}$                  |      | $\pm 100$ | mA   |
| $T_{stg}$      | Storage temperature                          |                                        | -65  | 150       | °C   |

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) For up to 4 outputs per device, add  $\pm 25$ mA for each additional output.

### 4.2 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|            |                               | CDx4AC245    |          | CDx4ACT245 |          | UNIT |
|------------|-------------------------------|--------------|----------|------------|----------|------|
|            |                               | MIN          | MAX      | MIN        | MAX      |      |
| $V_{CC}$   | Supply voltage <sup>(1)</sup> | 1.5V         | 5.5V     | 4.5V       | 5.5V     | V    |
| $V_I, V_O$ | Input or Output Voltage       | 0V           | $V_{CC}$ | 0V         | $V_{CC}$ | V    |
| dt/dv      | Input Rise and Fall Slew Rate | 1.5V to 3V   | 50       |            |          | ns   |
|            |                               | 3.6V to 5.5V | 20       |            |          |      |
|            |                               | 4.5V to 5.5V |          |            | 10       |      |
| $T_A$      | Temperature range             | - 55         | 125      | - 55       | 125      | °C   |

(1) Unless otherwise specified, all voltages are referenced to ground.

### 4.3 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                        | CDx4AC14/ CDx4ACT14 |           |           | UNIT |
|-------------------------------|----------------------------------------|---------------------|-----------|-----------|------|
|                               |                                        | N (PDIP)            | DW (SOIC) | DB (SSOP) |      |
|                               |                                        | 20 PINS             |           |           |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance | 69                  | 98.6      | 105.4     | °C/W |

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

## 4.4 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER       |                              | TEST CONDITIONS                                                  |                     | V <sub>CC</sub> | T <sub>A</sub> = 25°C |      | -40°C TO 85°C |                  | -55°C TO 125°C |     | UNIT |
|-----------------|------------------------------|------------------------------------------------------------------|---------------------|-----------------|-----------------------|------|---------------|------------------|----------------|-----|------|
|                 |                              | V <sub>I</sub> (V)                                               | I <sub>O</sub> (mA) |                 | MIN                   | MAX  | MIN           | MAX              | MIN            | MAX |      |
| AC TYPES        |                              |                                                                  |                     |                 |                       |      |               |                  |                |     |      |
| V <sub>IH</sub> | High-level input voltage     |                                                                  |                     | 1.5             | 1.2                   | 1.2  | 1.2           | V                |                |     |      |
|                 |                              |                                                                  |                     | 3               | 2.1                   | 2.1  | 2.1           |                  |                |     |      |
|                 |                              |                                                                  |                     | 5.5             | 3.85                  | 3.85 | 3.85          |                  |                |     |      |
| V <sub>IL</sub> | Low-level input voltage      | V <sub>IL</sub>                                                  |                     | 1.5             | 0.3                   | 0.3  | 0.3           | V                |                |     |      |
|                 |                              |                                                                  |                     | 3               | 0.9                   | 0.9  | 0.9           |                  |                |     |      |
|                 |                              |                                                                  |                     | 5.5             | 1.65                  | 1.65 | 1.65          |                  |                |     |      |
| V <sub>OH</sub> | High-level output voltage    | V <sub>IH</sub> or V <sub>IL</sub>                               | -0.05               | 1.5             | 1.4                   | 1.4  | 1.4           | V <sub>VOH</sub> |                |     |      |
|                 |                              |                                                                  | -0.05               | 3               | 2.9                   | 2.9  | 2.9           |                  |                |     |      |
|                 |                              |                                                                  | -0.05               | 4.5             | 4.4                   | 4.4  | 4.4           |                  |                |     |      |
|                 |                              |                                                                  | -4                  | 3               | 2.58                  | 2.48 | 2.4           |                  |                |     |      |
|                 |                              |                                                                  | -24                 | 4.5             | 3.94                  | 3.8  | 3.7           |                  |                |     |      |
|                 |                              |                                                                  | -75                 | 5.5             | 3.85                  |      |               |                  |                |     |      |
|                 |                              |                                                                  | -50                 | 5.5             |                       | 3.85 |               |                  |                |     |      |
| V <sub>OL</sub> | Low-level output voltage     | V <sub>IH</sub> or V <sub>IL</sub>                               | 0.05                | 1.5 V           | 0.1                   | 0.1  | 0.1           | V                |                |     |      |
|                 |                              |                                                                  | 0.05                | 3 V             | 0.1                   | 0.1  | 0.1           |                  |                |     |      |
|                 |                              |                                                                  | 0.05                | 4.5 V           | 0.1                   | 0.1  | 0.1           |                  |                |     |      |
|                 |                              |                                                                  | 12                  | 3 V             | 0.36                  | 0.44 | 0.5           |                  |                |     |      |
|                 |                              |                                                                  | 24                  | 4.5 V           | 0.36                  | 0.44 | 0.5           |                  |                |     |      |
|                 |                              |                                                                  | 75 <sup>1</sup>     | 5.5 V           | 1.65                  |      |               |                  |                |     |      |
|                 |                              |                                                                  | 50 <sup>1</sup>     | 5.5 V           |                       | 1.65 |               |                  |                |     |      |
| I <sub>I</sub>  | Input leakage current        | V <sub>CC</sub> or GND                                           |                     | 5.5             | ± 0.1                 | ± 1  | ± 1           | μ A              |                |     |      |
| I <sub>OZ</sub> | Three-state leakage current  | V <sub>IH</sub> or V <sub>IL</sub> , VO = V <sub>CC</sub> or GND |                     | 5.5 V           | ± 0.5                 | ± 5  | ± 10          | μ A              |                |     |      |
| I <sub>CC</sub> | Quiescent supply current MSI | V <sub>CC</sub> or GND                                           | 0                   | 5.5 V           | 8                     | 80   | 160           | μ A              |                |     |      |
| ACT TYPES       |                              |                                                                  |                     |                 |                       |      |               |                  |                |     |      |
| V <sub>IH</sub> | High-level input voltage     |                                                                  |                     | 4.5 V to 5.5 V  | 2                     | 2    | 2             | V                |                |     |      |
| V <sub>IL</sub> | Low-level input voltage      |                                                                  |                     | 4.5 V to 5.5 V  | 0.8                   | 0.8  | 0.8           | V                |                |     |      |
| V <sub>OH</sub> | High-level output voltage    | V <sub>IH</sub> or V <sub>IL</sub>                               | -0.05               | 4.5 V           | 4.4                   | 4.4  | 4.4           | 0.8              | V              |     |      |
|                 |                              |                                                                  | -24                 | 4.5 V           | 3.94                  | 3.8  | 3.7           |                  |                |     |      |
|                 |                              |                                                                  | -75 <sup>1</sup>    | 5.5 V           |                       | 3.85 |               |                  |                |     |      |
|                 |                              |                                                                  | -50                 | 5.5 V           |                       |      | 3.85          |                  |                |     |      |

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                                                                           | TEST CONDITIONS                              |                 | $V_{CC}$   | $T_A = 25^\circ\text{C}$ |           | $-40^\circ\text{C TO } 85^\circ\text{C}$ |         | $-55^\circ\text{C TO } 125^\circ\text{C}$ |          | UNIT          |
|-------------------------------------------------------------------------------------|----------------------------------------------|-----------------|------------|--------------------------|-----------|------------------------------------------|---------|-------------------------------------------|----------|---------------|
|                                                                                     | $V_I$ (V)                                    | $I_O$ (mA)      |            | MIN                      | MAX       | MIN                                      | MAX     | MIN                                       | MAX      |               |
| $V_{OL}$ Low-level output voltage                                                   | $V_{IH}$ or $V_{IL}$                         | 0.05            | 4.5        |                          | 0.1       |                                          | 0.1     |                                           | 0.1      | V             |
|                                                                                     |                                              | 24              | 4.5        |                          | 0.36      |                                          | 0.44    |                                           | 0.5      |               |
|                                                                                     |                                              | 75 <sup>1</sup> | 5.5        |                          |           |                                          | 1.65    |                                           |          |               |
|                                                                                     |                                              | 50 <sup>1</sup> | 5.5        |                          |           |                                          |         |                                           | 1.65     |               |
|                                                                                     |                                              |                 |            |                          |           |                                          |         |                                           |          | V             |
| $I_I$ Input leakage current                                                         | $V_{CC}$ or GND                              |                 | 5.5 V      |                          | $\pm 0.1$ |                                          | $\pm 1$ |                                           | $\pm 1$  | $\mu\text{A}$ |
| $I_{OZ}$ Three-state or leakage current                                             | $V_{IH}$ or $V_{IL}$ , $V_O = V_{CC}$ or GND |                 | 5.5 V      |                          | $\pm 0.5$ |                                          | $\pm 5$ |                                           | $\pm 10$ | $\mu\text{A}$ |
| $I_{CC}$ Quiescent supply current MSI                                               | $V_{CC}$ or GND                              | 0               | 5.5 V      |                          | 8         |                                          | 80      |                                           | 160      | $\mu\text{A}$ |
| $\Delta I_{CC}$ Additional supply current per input pin TTL inputs high 1 unit load | $V_{CC} - 2.1$                               |                 | 4.5 to 5.5 |                          | 2.4       |                                          | 2.8     |                                           | 3        | mA            |

- Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation. Test verifies a minimum  $50\Omega$  transmission-line-drive capability at  $85^\circ\text{C}$ ,  $75\Omega$  at  $125^\circ\text{C}$ .

## 4.5 Switching Characteristics

Input  $t_r$ ,  $t_f = 3\text{ns}$ ,  $C_L = 50\text{pF}$  (Worst Case). Over recommended operating free-air temperature range (unless otherwise noted) (see [Load Circuit and Voltage Waveforms](#))

| PARAMETER                           |                                                                                                      | V <sub>CC</sub> (V) | -40°C TO 85°C |     |     | -55°C TO 125°C |     |     | UNIT |
|-------------------------------------|------------------------------------------------------------------------------------------------------|---------------------|---------------|-----|-----|----------------|-----|-----|------|
|                                     |                                                                                                      |                     | MIN           | TYP | MAX | MIN            | TYP | MAX |      |
| AC TYPES                            |                                                                                                      |                     |               |     |     |                |     |     |      |
| t <sub>PLH</sub> , t <sub>PHL</sub> | Propagation delay, data to output                                                                    | 1.5                 | 96            |     |     | 106            |     |     | ns   |
|                                     |                                                                                                      | 3.3                 | 10.8          |     |     | 11.9           |     |     |      |
|                                     |                                                                                                      | 5                   | 7.7           |     |     | 8.5            |     |     |      |
| t <sub>PLZ</sub> , t <sub>PHZ</sub> | Propagation delay, output disable to output                                                          | 1.5                 | 159           |     |     | 175            |     |     | ns   |
|                                     |                                                                                                      | 3.3                 | 15.9          |     |     | 17.5           |     |     |      |
|                                     |                                                                                                      | 5                   | 12.7          |     |     | 14             |     |     |      |
| t <sub>PZL</sub> , t <sub>PZH</sub> | Propagation delay, output enable to output                                                           | 1.5                 | 159           |     |     | 175            |     |     | ns   |
|                                     |                                                                                                      | 3.3                 | 19            |     |     | 21             |     |     |      |
|                                     |                                                                                                      | 5                   | 12.7          |     |     |                |     |     |      |
| V <sub>OHV</sub>                    | Minimum (Valley) V <sub>OH</sub> During switching of other outputs (output under test not switching) | 5                   | 4 at 25°C     |     |     | 4 at 25°C      |     |     | V    |

Input  $t_r$ ,  $t_f$  = 3ns,  $C_L$  = 50pF (Worst Case). Over recommended operating free-air temperature range (unless otherwise noted) (see [Load Circuit and Voltage Waveforms](#))

| PARAMETER                           |                                                                                                      | V <sub>CC</sub> (V) | -40°C TO 85°C |     |     | -55°C TO 125°C |     |     | UNIT |    |
|-------------------------------------|------------------------------------------------------------------------------------------------------|---------------------|---------------|-----|-----|----------------|-----|-----|------|----|
|                                     |                                                                                                      |                     | MIN           | TYP | MAX | MIN            | TYP | MAX |      |    |
| V <sub>OLP</sub>                    | Maximum (Peak) V <sub>OL</sub> During switching of other outputs (output under test not switching)   | 5                   | 1 at 25°C     |     |     | 1 at 25°C      |     |     | V    |    |
| C <sub>O</sub>                      | Three-state output capacitance                                                                       |                     | 15            |     |     | 15             |     |     | pF   |    |
| C <sub>I</sub>                      | Input capacitance                                                                                    |                     | 10            |     |     | 10             |     |     | pF   |    |
| C <sub>PD</sub>                     | Power dissipation capacitance                                                                        |                     | 57            |     |     | 57             |     |     | pF   |    |
| ACT TYPES                           |                                                                                                      |                     |               |     |     |                |     |     |      |    |
| t <sub>PLH</sub> , t <sub>PHL</sub> | Propagation delay, data to output                                                                    | 5                   | 2.7           |     |     | 2.5            |     |     | 10   | ns |
| t <sub>PLZ</sub> , t <sub>PHZ</sub> | Propagation delay, output disable to output                                                          | 5                   | 3.7           |     |     | 3.5            |     |     | 14   | ns |
| t <sub>PZL</sub> , t <sub>PZH</sub> | Propagation delay, output enable to output                                                           | 5                   | 3.8           |     |     | 3.6            |     |     | 14.4 | ns |
| V <sub>OHV</sub>                    | Minimum (Valley) V <sub>OH</sub> During switching of other outputs (output under test not switching) | 5                   | 4 at 25°C     |     |     | 4 at 25°C      |     |     |      | V  |
| V <sub>OLP</sub>                    | Maximum (Peak) V <sub>OL</sub> During switching of other outputs (output under test not switching)   | 5                   | 1 at 25°C     |     |     | 1 at 25°C      |     |     |      | V  |
| C <sub>O</sub>                      | Three-state output capacitance                                                                       |                     | 15            |     |     | 15             |     |     |      | pF |
| C <sub>I</sub>                      | Input capacitance                                                                                    |                     | 10            |     |     | 10             |     |     |      | pF |
| C <sub>PD</sub>                     | Power dissipation capacitance                                                                        |                     | 57            |     |     | 57             |     |     |      | pF |

- Limits tested 100%
- 3.3V Min is at 3.6V, Max is at 3V
- 5V Min is at 5.5V, Max is at 4.5V
- CPD is used to determine the dynamic power consumption per channel
  - AC:  $PD = V_{CC}^2 f_i (CPD + CL)$
  - ACT:  $PD = V_{CC}^2 f_i (CPD + CL) + V_{CC} \Delta ICC$  where  $f_i$  = input frequency,  $CL$  = output load capacitance,  $V_{CC}$  = supply voltage

## 4.6 Timing Diagrams

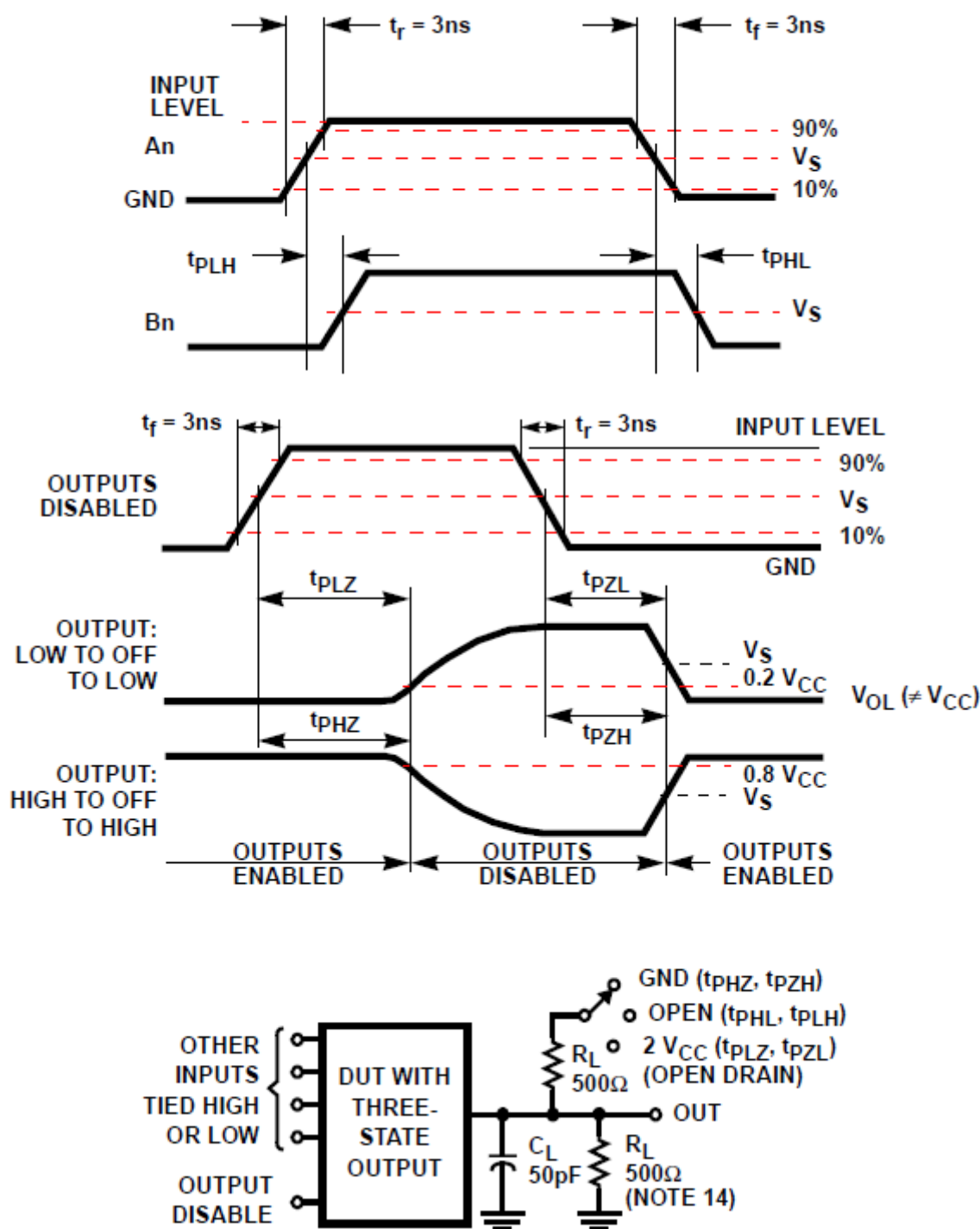


图 4-1. THREE-STATE PROPAGATION DELAY TIMES AND TEST CIRCUIT

图 4-1. SIMULTANEOUS SWITCHING TRANSIENT WAVEFORMS

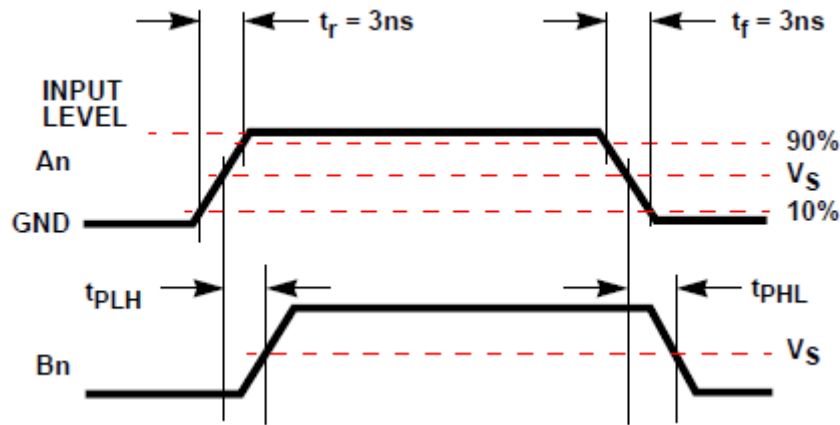
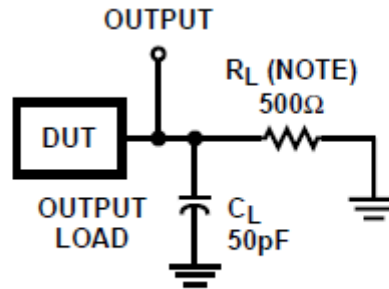


图 4-3. PROPAGATION DELAY TIMES



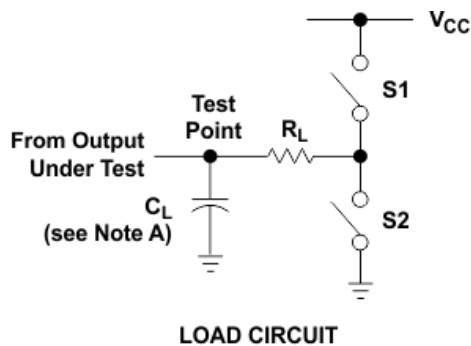
NOTE: For AC Series Only: When  $V_{CC} = 1.5V$ ,  $R_L = 1k\Omega$ .

表 4-1.

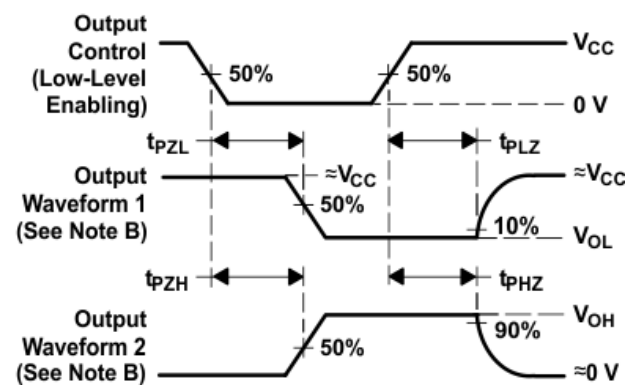
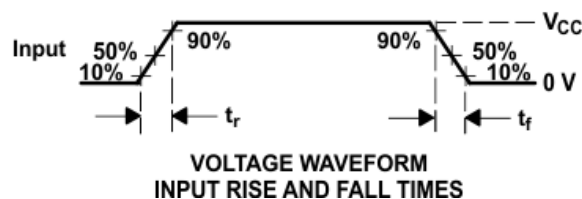
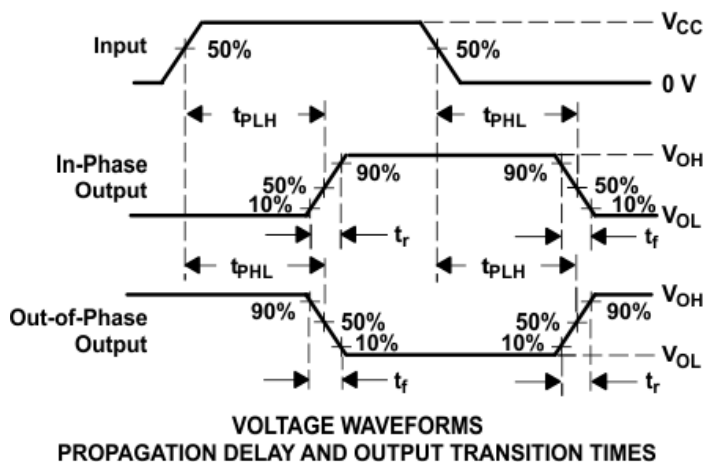
|                                 | AC           | ACT          |
|---------------------------------|--------------|--------------|
| Input Level                     | $V_{CC}$     | 3V           |
| Input Switching Voltage, $V_S$  | $0.5 V_{CC}$ | 1.5V         |
| Output Switching Voltage, $V_S$ | $0.5 V_{CC}$ | $0.5 V_{CC}$ |

图 4-4. PROPAGATION DELAY TIMES

## 5 Parameter Measurement Information



| PARAMETER         |           | $R_L$        | $C_L$           | S1     | S2     |
|-------------------|-----------|--------------|-----------------|--------|--------|
| $t_{en}$          | $t_{pZH}$ | 1 k $\Omega$ | 50 pF or 150 pF | Open   | Closed |
|                   | $t_{pZL}$ |              |                 | Closed | Open   |
| $t_{dis}$         | $t_{pHZ}$ | 1 k $\Omega$ | 50 pF           | Open   | Closed |
|                   | $t_{pLZ}$ |              |                 | Closed | Open   |
| $t_{pd}$ or $t_t$ |           | --           | 50 pF or 150 pF | Open   | Open   |

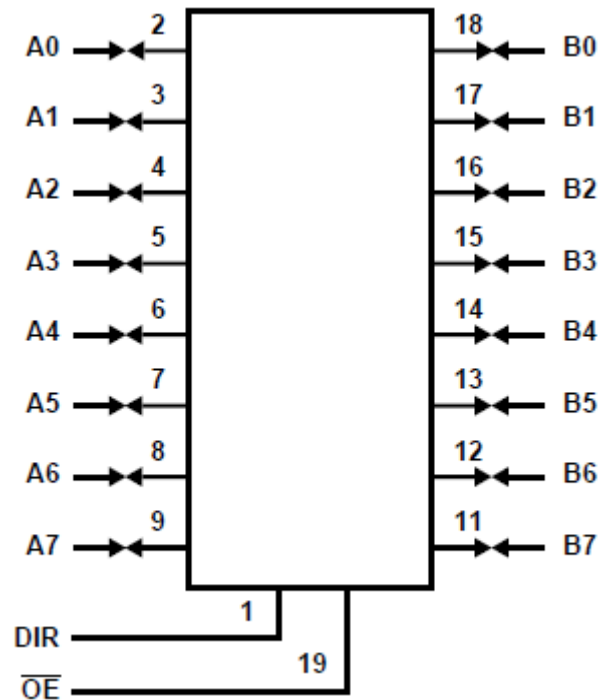


## 6 Detailed Description

### 6.1 Overview

The 'AC245 and 'ACT245 are non-inverting three-state bidirectional transceiver-buffers intended for two-way transmission from “A” bus to “B” bus or “B” bus to “A”. The logic level present on the direction input (DIR) determines the data direction. When the output enable input (OE) is HIGH, the outputs are in the high-impedance state.

### 6.2 Functional Block Diagram



Logic Diagram (Positive Logic)

### 6.3 Device Functional Modes

Function Table lists the function modes of the CDx4AC245, CDx4ACT245.

表 6-1. Function Table

| INPUTS <sup>(1)</sup> |     | OPERATION       |
|-----------------------|-----|-----------------|
| OE                    | DIR |                 |
| L                     | L   | B data to A bus |
| L                     | H   | A data to B bus |
| H                     | X   | Isolation       |

(1) H = High Voltage Level, L = Low Voltage Level, X = Don't Care

## 7 Application and Implementation

### 备注

以下应用部分中的信息不属于 TI 器件规格的范围，TI 不担保其准确性和完整性。TI 的客户应负责确定器件是否适用于其应用。客户应验证并测试其设计，以确保系统功能。

### 7.1 Power Supply Recommendations

The power supply can be any voltage between the MIN and MAX supply voltage rating located in the [节 4.2](#).

Each  $V_{CC}$  pin should have a good bypass capacitor to prevent power disturbance. For devices with a single supply, 0.1  $\mu F$  is recommended; if there are multiple  $V_{CC}$  pins, then 0.01  $\mu F$  or 0.022  $\mu F$  is recommended for each power pin. It is acceptable to parallel multiple bypass caps to reject different frequencies of noise. A 0.1  $\mu F$  and a 1  $\mu F$  are commonly used in parallel. The bypass capacitor should be installed as close to the power pin as possible for best results.

### 7.2 Layout

#### 7.2.1 Layout Guidelines

When using multiple-bit logic devices, inputs should never float.

In many cases, functions or parts of functions of digital logic devices are unused, for example, when only two inputs of a triple-input AND gate are used or only 3 of the 4 buffer gates are used. Such input pins should not be left unconnected because the undefined voltages at the outside connections result in undefined operational states. [节 7.2.2](#) specifies the rules that must be observed under all circumstances. All unused inputs of digital logic devices must be connected to a high or low bias to prevent them from floating. The logic level that should be applied to any particular unused input depends on the function of the device. Generally they will be tied to GND or  $V_{CC}$ , whichever makes more sense or is more convenient. It is generally acceptable to float outputs, unless the part is a transceiver. If the transceiver has an output enable pin, it will disable the output section of the part when asserted. This will not disable the input section of the IOs, so they cannot float when disabled.

#### 7.2.2 Layout Example

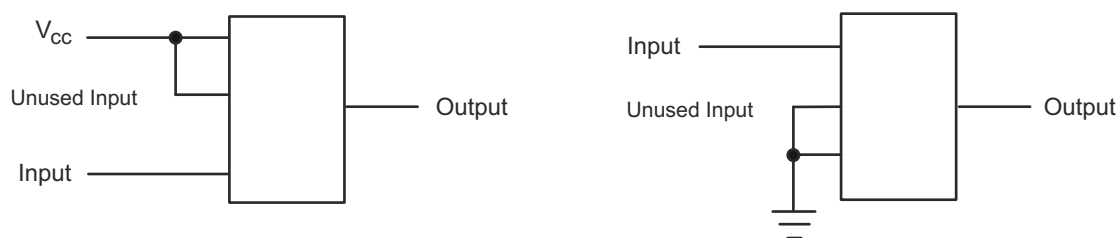


图 7-1. Layout Diagram

## 8 Device and Documentation Support

### 8.1 Documentation Support

#### 8.1.1 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

表 8-1. Related Links

| PARTS      | PRODUCT FOLDER             | SAMPLE & BUY               | TECHNICAL DOCUMENTS        | TOOLS & SOFTWARE           | SUPPORT & COMMUNITY        |
|------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| CD54AC245  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| CD74AC245  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| CD54ACT245 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| CD74ACT245 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |

### 8.2 接收文档更新通知

要接收文档更新通知，请导航至 [ti.com](https://ti.com) 上的器件产品文件夹。点击 [通知](#) 进行注册，即可每周接收产品信息更改摘要。有关更改的详细信息，请查看任何已修订文档中包含的修订历史记录。

### 8.3 支持资源

**TI E2E™ 中文支持论坛**是工程师的重要参考资料，可直接从专家处获得快速、经过验证的解答和设计帮助。搜索现有解答或提出自己的问题，获得所需的快速设计帮助。

链接的内容由各个贡献者“按原样”提供。这些内容并不构成 TI 技术规范，并且不一定反映 TI 的观点；请参阅 TI 的[使用条款](#)。

### 8.4 Trademarks

TI E2E™ is a trademark of Texas Instruments.

所有商标均为其各自所有者的财产。

### 8.5 静电放电警告



静电放电 (ESD) 会损坏这个集成电路。德州仪器 (TI) 建议通过适当的预防措施处理所有集成电路。如果不遵守正确的处理和安装程序，可能会损坏集成电路。

ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

### 8.6 术语表

**TI 术语表** 本术语表列出并解释了术语、首字母缩略词和定义。

## 9 Revision History

注：以前版本的页码可能与当前版本的页码不同

| Changes from Revision C (May 2023) to Revision D (April 2024)                                  | Page |
|------------------------------------------------------------------------------------------------|------|
| • 添加了 <i>应用和实施</i> 部分、 <i>器件和文档支持</i> 部分，并向 <i>器件信息</i> 表添加了封装尺寸.....                          | 1    |
| • Updated R <sub>θJA</sub> values: DW = 58 to 98.6, DB = 70 to 105.4, all values in °C/W ..... | 4    |

| Changes from Revision B (April 2002) to Revision C (May 2023) | Page |
|---------------------------------------------------------------|------|
| • 添加了 <i>封装信息</i> 表、 <i>引脚功能</i> 表和 <i>热性能信息</i> 表.....       | 1    |

## 10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number          | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|--------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">CD54AC245F3A</a>   | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD54AC245F3A        |
| CD54AC245F3A.A                 | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD54AC245F3A        |
| <a href="#">CD54ACT245F3A</a>  | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD54ACT245F3A       |
| CD54ACT245F3A.A                | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD54ACT245F3A       |
| <a href="#">CD74AC245E</a>     | Active        | Production           | PDIP (N)   20  | 20   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74AC245E          |
| CD74AC245E.A                   | Active        | Production           | PDIP (N)   20  | 20   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74AC245E          |
| CD74AC245EE4                   | Active        | Production           | PDIP (N)   20  | 20   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74AC245E          |
| <a href="#">CD74AC245M</a>     | Obsolete      | Production           | SOIC (DW)   20 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | AC245M              |
| <a href="#">CD74AC245M96</a>   | Active        | Production           | SOIC (DW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | AC245M              |
| CD74AC245M96.A                 | Active        | Production           | SOIC (DW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | AC245M              |
| <a href="#">CD74ACT245E</a>    | NRND          | Production           | PDIP (N)   20  | 20   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74ACT245E         |
| CD74ACT245E.A                  | NRND          | Production           | PDIP (N)   20  | 20   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74ACT245E         |
| CD74ACT245EE4                  | NRND          | Production           | PDIP (N)   20  | 20   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74ACT245E         |
| <a href="#">CD74ACT245M</a>    | Obsolete      | Production           | SOIC (DW)   20 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | ACT245M             |
| <a href="#">CD74ACT245M96</a>  | Active        | Production           | SOIC (DW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | (ACT245, ACT245M)   |
| CD74ACT245M96.A                | Active        | Production           | SOIC (DW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | (ACT245, ACT245M)   |
| <a href="#">CD74ACT245SM96</a> | Active        | Production           | SSOP (DB)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | (ACT245, ACT245SM)  |
| CD74ACT245SM96.A               | Active        | Production           | SSOP (DB)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | (ACT245, ACT245SM)  |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF CD54AC245, CD54ACT245, CD74AC245, CD74ACT245 :**

- Catalog : [CD74AC245](#), [CD74ACT245](#)
- Military : [CD54AC245](#), [CD54ACT245](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CD74AC245M96   | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |
| CD74ACT245M96  | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.9    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |
| CD74ACT245M96  | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |
| CD74ACT245SM96 | SSOP         | DB              | 20   | 2000 | 330.0              | 16.4               | 8.2     | 7.5     | 2.5     | 12.0    | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD74AC245M96   | SOIC         | DW              | 20   | 2000 | 356.0       | 356.0      | 45.0        |
| CD74ACT245M96  | SOIC         | DW              | 20   | 2000 | 356.0       | 356.0      | 45.0        |
| CD74ACT245M96  | SOIC         | DW              | 20   | 2000 | 356.0       | 356.0      | 45.0        |
| CD74ACT245SM96 | SSOP         | DB              | 20   | 2000 | 353.0       | 353.0      | 32.0        |

**TUBE**

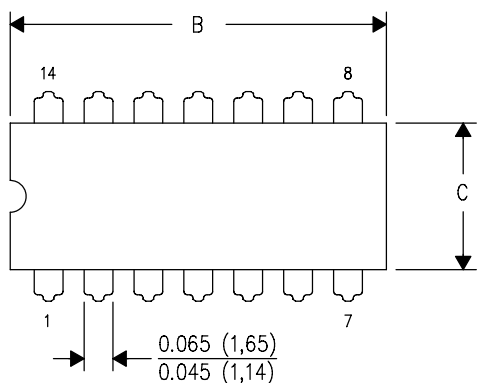

\*All dimensions are nominal

| Device        | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|---------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| CD74AC245E    | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| CD74AC245E.A  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| CD74AC245EE4  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| CD74ACT245E   | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| CD74ACT245E.A | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| CD74ACT245EE4 | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |

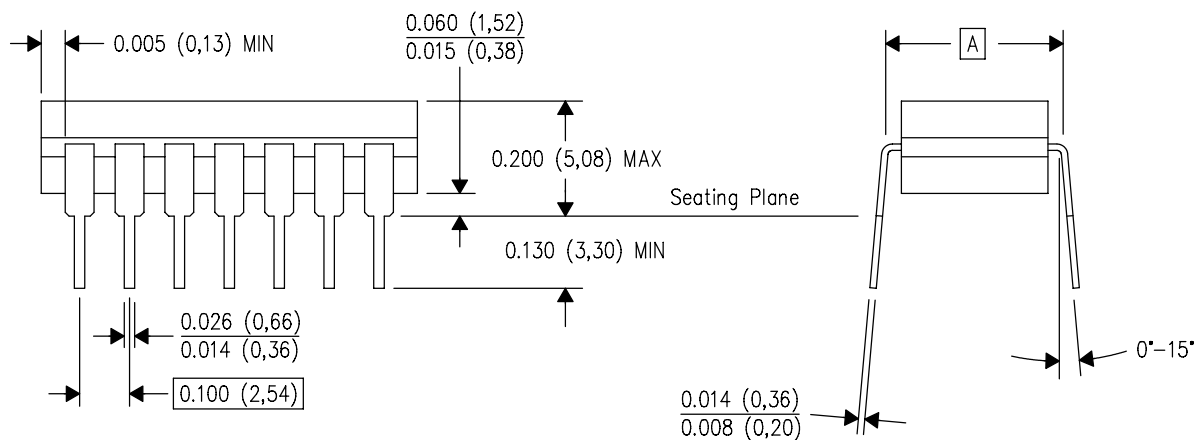
J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



| PINS **<br>DIM | 14                     | 16                     | 18                     | 20                     |
|----------------|------------------------|------------------------|------------------------|------------------------|
| A              | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX          | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN          | —                      | —                      | —                      | —                      |
| C MAX          | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN          | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



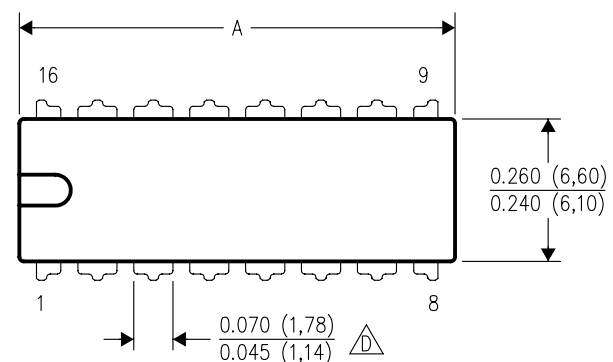
4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

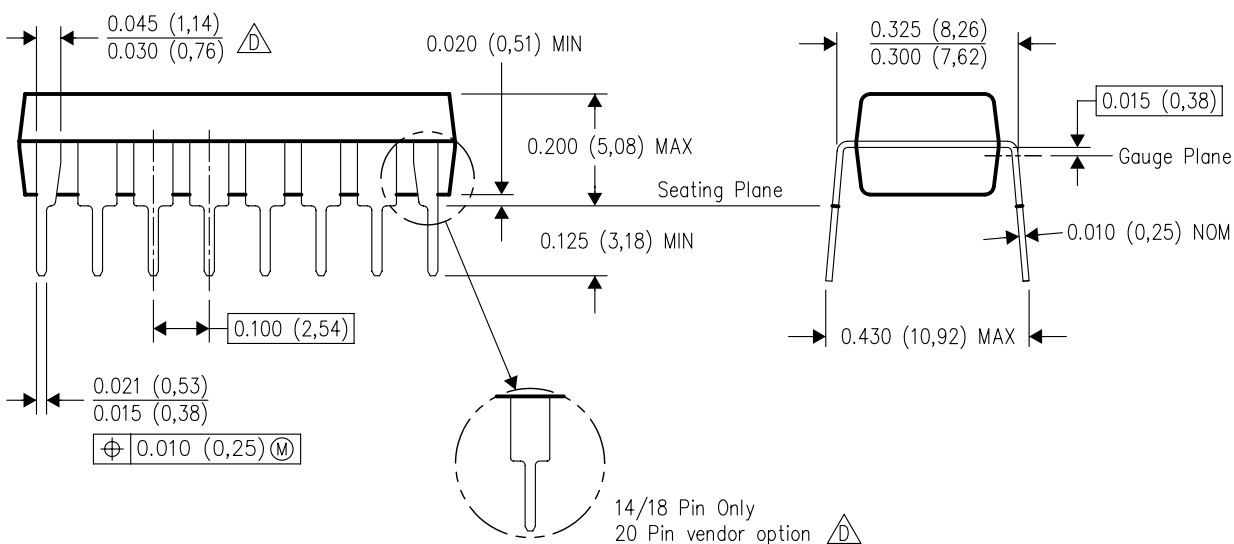
N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



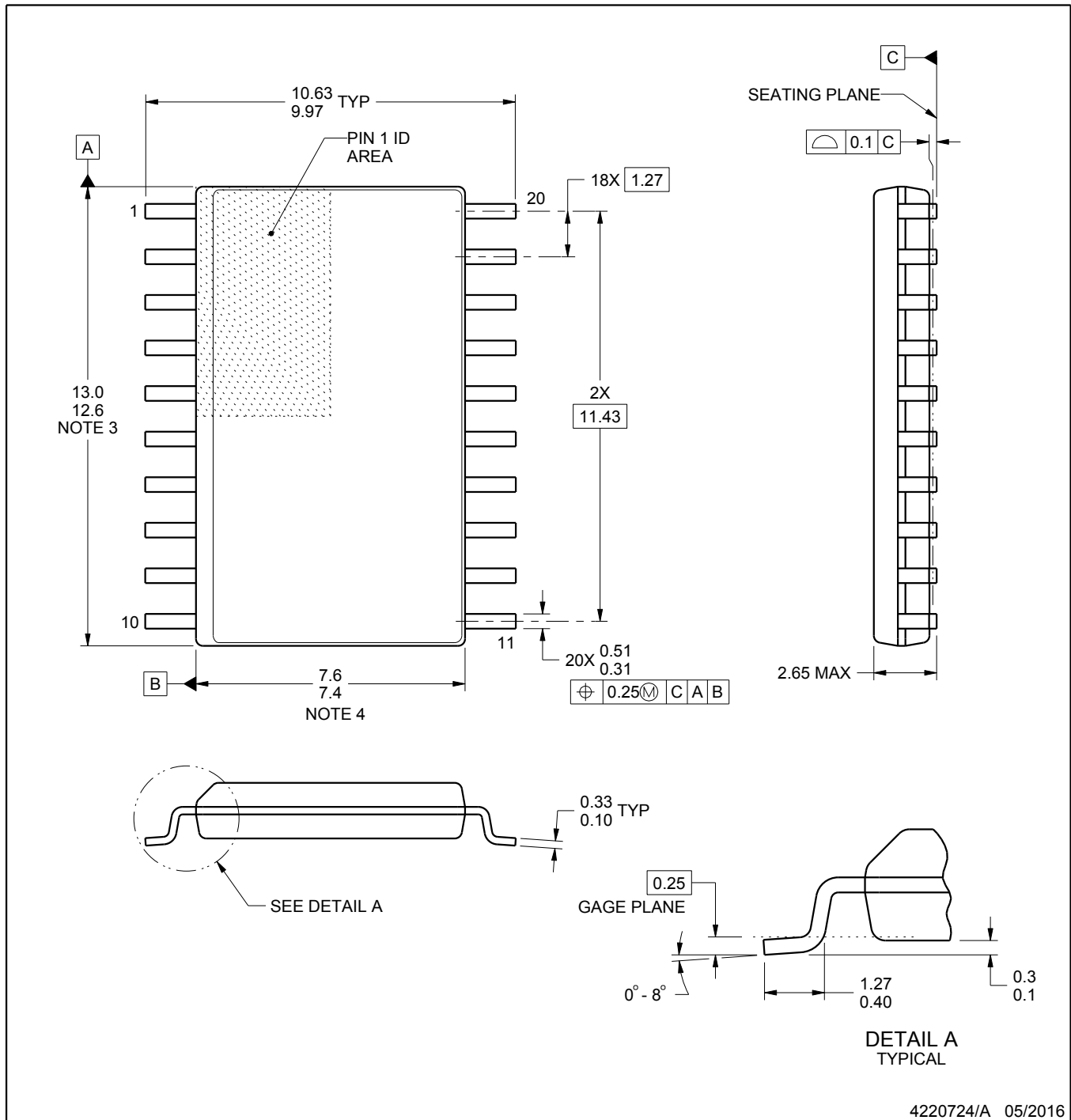
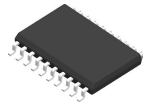
| PINS **<br>DIM      | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



4040049/E 12/2002

NOTES:

- A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).  
 The 20 pin end lead shoulder width is a vendor option, either half or full width.



## NOTES:

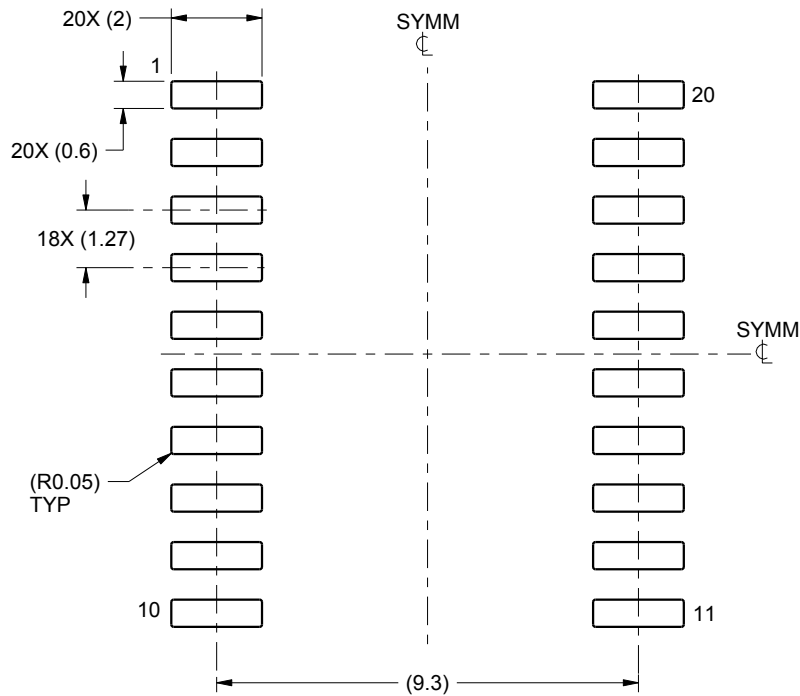
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

# EXAMPLE BOARD LAYOUT

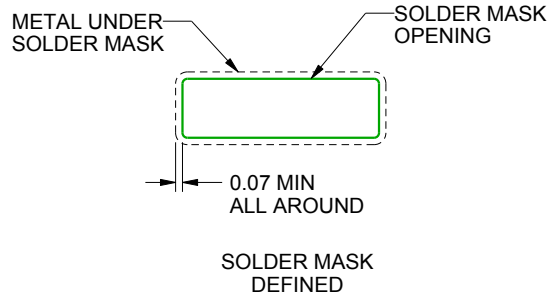
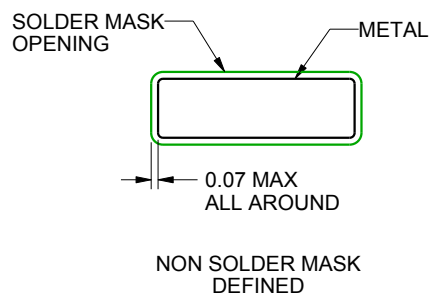
DW0020A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

4220724/A 05/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

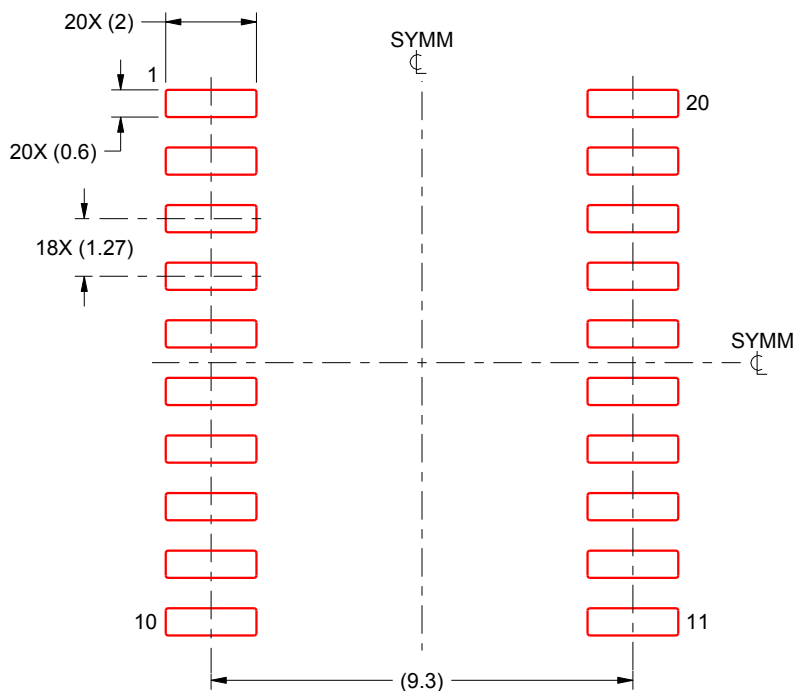
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

4220724/A 05/2016

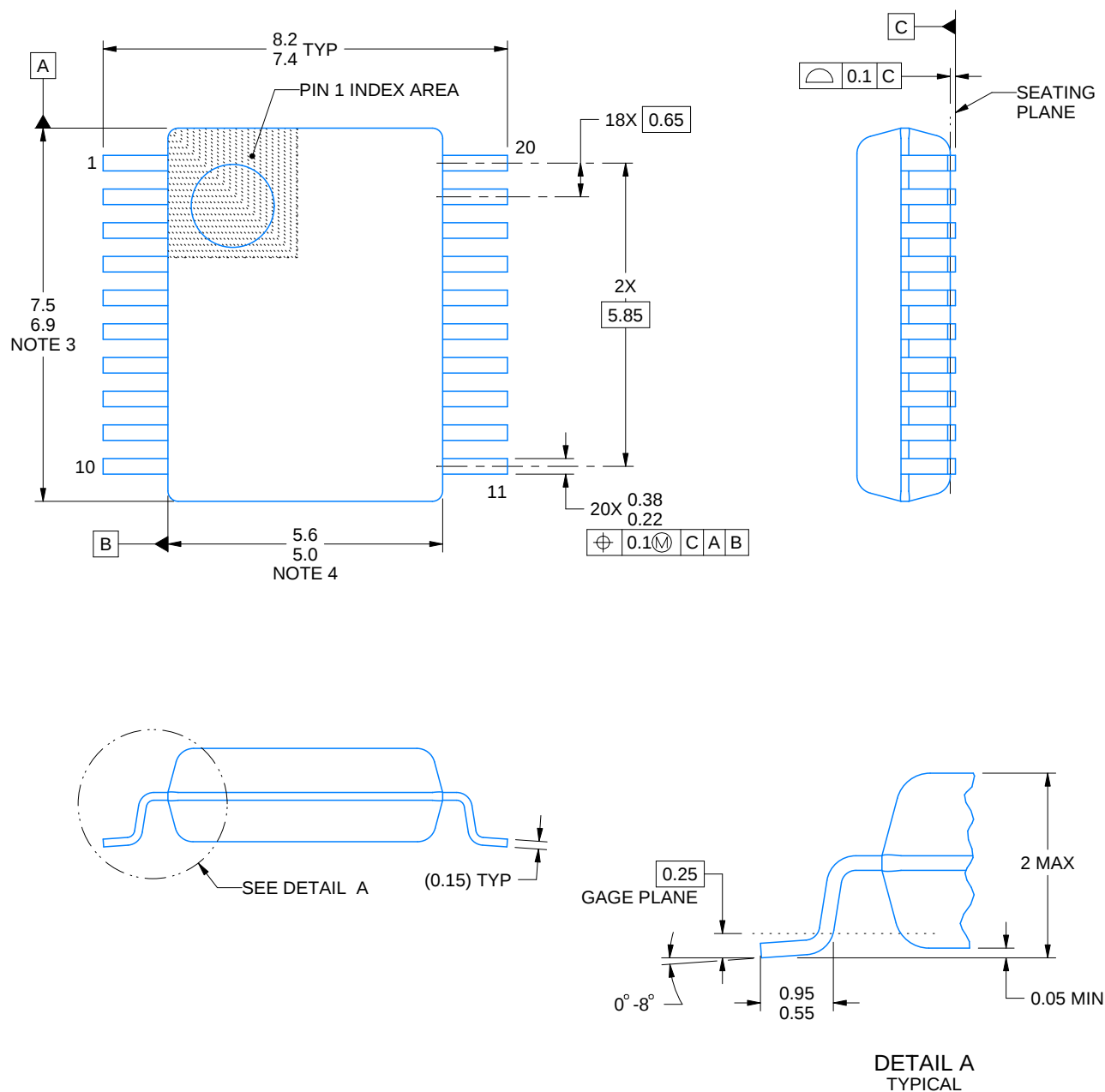
NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



## SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



4214851/B 08/2019

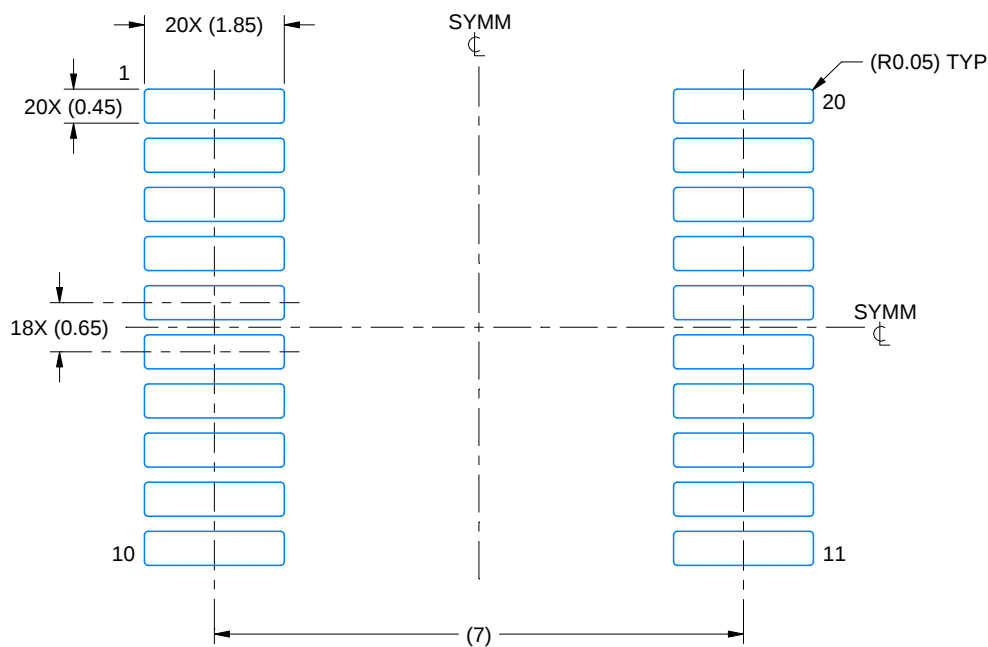
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-150.

# EXAMPLE BOARD LAYOUT

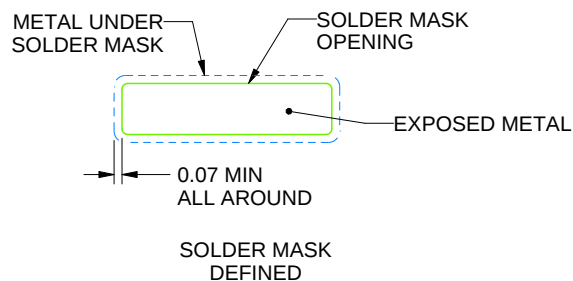
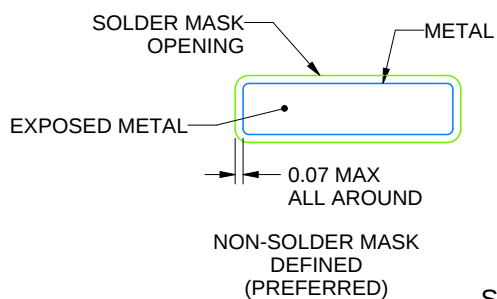
DB0020A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



SOLDER MASK DETAILS

4214851/B 08/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

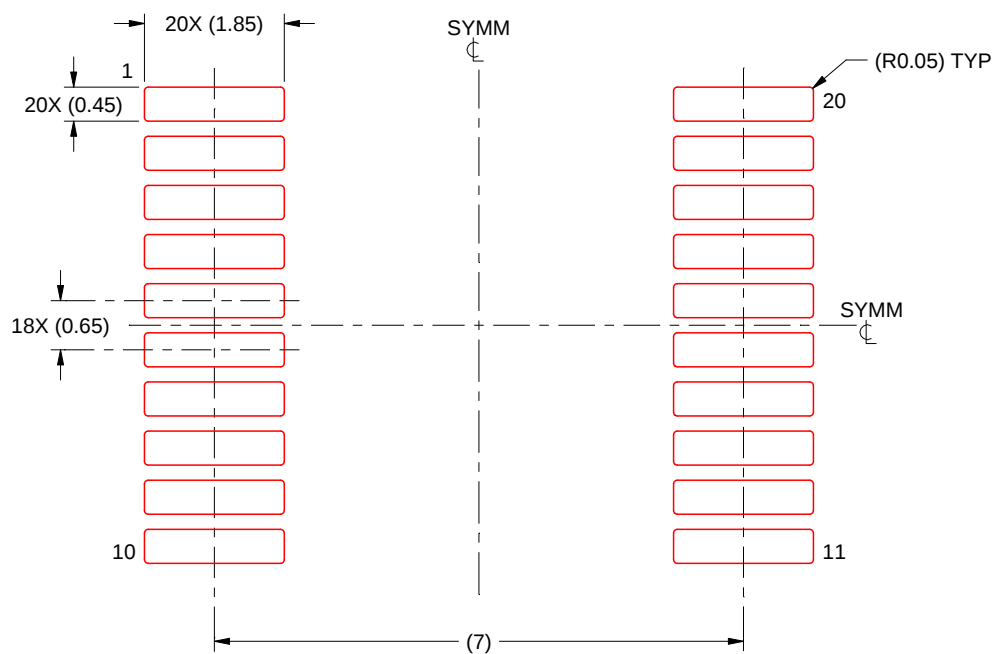
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DB0020A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4214851/B 08/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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最后更新日期：2025 年 10 月